

FGPF7N60RUFD

600V, 7A RUF IGBT CO-PAK

Features

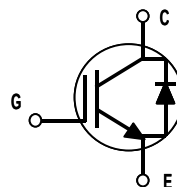
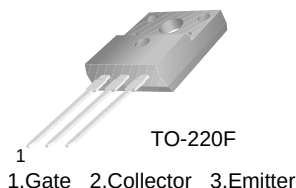
- High speed switching
- Low saturation voltage : $V_{CE(sat)} = 1.95\text{ V @ } I_C = 7\text{ A}$
- High input impedance
- CO-PAK, IGBT with FRD : $t_{rr} = 50\text{ ns (typ.)}$
- Short Circuit rated, 10us @ $T_C = 100^\circ\text{C}$, $V_{GE} = 15\text{V}$, $V_{CE} = 300\text{V}$

Applications

Motor controls and general purpose inverters.

Description

Fairchild's Insulated Gate Bipolar Transistors (IGBTs) provides low conduction and switching losses. The device is designed for Motor applications where ruggedness is a required feature.



Absolute Maximum Ratings

Symbol	Description	FGP7N60RUFD	Units
V_{CES}	Collector-Emitter Voltage	600	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Collector Current @ $T_C = 25^\circ\text{C}$	14	A
	Collector Current @ $T_C = 100^\circ\text{C}$	7	A
I_{CM} (1)	Pulsed Collector Current	21	A
I_F	Diode Continuous Forward Current @ $T_C = 100^\circ\text{C}$	12	A
I_{FM}	Diode Maximum Forward Current	60	A
P_D	Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$	41	W
	Maximum Power Dissipation @ $T_C = 100^\circ\text{C}$	16	W
T_J	Operating Junction Temperature	-55 to +150	$^\circ\text{C}$
T_{stg}	Storage Temperature Range	-55 to +150	$^\circ\text{C}$
T_L	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds	300	$^\circ\text{C}$

Notes :

(1) Repetitive rating : Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction-to-Case	--	3.0	$^\circ\text{C/W}$
$R_{\theta JC}$ (DIODE)	Thermal Resistance, Junction-to-Case	--	4.2	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	--	62.5	$^\circ\text{C/W}$

Package Marking and Ordering Information

Device Marking	Device	Package	Packaging Type	Qty per Tube	Max Qty per Box
FGPF7N60RUFD	FGPF7N60RUFD TU	TO-220F	Rail / Tube	50ea	-

Electrical Characteristics of the IGBT T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
Off Characteristics						
BV _{CES}	Collector-Emitter Breakdown Voltage	V _{GE} = 0V, I _C = 250uA	600	--	--	V
ΔB _{V_{CES}} /ΔT _J	Temperature Coefficient of Breakdown Voltage	V _{GE} = 0V, I _C = 3mA	--	0.6	--	V/°C
I _{CES}	Collector Cut-Off Current	V _{CE} = V _{CES} , V _{GE} = 0V	--	--	250	uA
I _{GES}	G-E Leakage Current	V _{GE} = V _{GES} , V _{CE} = 0V	--	--	± 100	nA
On Characteristics						
V _{GE(th)}	G-E Threshold Voltage	I _C = 7mA, V _{CE} = V _{GE}	5.0	6.5	8.0	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C = 7A, V _{GE} = 15V	--	1.95	2.8	V
		I _C = 7A, V _{GE} = 15V, T _C = 125°C	--	2.1	--	V
		I _C = 14 A, V _{GE} = 15V	--	2.65	--	V
Dynamic Characteristics						
C _{ies}	Input Capacitance	V _{CE} = 30V, V _{GE} = 0V, f = 1MHz	--	510	--	pF
C _{oes}	Output Capacitance		--	55	--	pF
C _{res}	Reverse Transfer Capacitance		--	15	--	pF
Switching Characteristics						
t _{d(on)}	Turn-On Delay Time	V _{CC} = 300 V, I _C = 7A, R _G = 30Ω, V _{GE} = 15V, Inductive Load, T _C = 25°C	--	60	--	ns
t _r	Rise Time		--	60	--	ns
t _{d(off)}	Turn-Off Delay Time		--	60	80	ns
t _f	Fall Time		--	170	280	ns
E _{on}	Turn-On Switching Loss		--	0.23	--	mJ
E _{off}	Turn-Off Switching Loss		--	0.10	--	mJ
E _{ts}	Total Switching Loss	V _{CC} = 300 V, I _C = 7 A, R _G =30Ω, V _{GE} = 15V, Inductive Load, T _C = 125°C	--	0.33	0.5	mJ
t _{d(on)}	Turn-On Delay Time		--	65	--	ns
t _r	Rise Time		--	70	--	ns
t _{d(off)}	Turn-Off Delay Time		--	55	--	ns
t _f	Fall Time		--	350	--	ns
E _{on}	Turn-On Switching Loss		--	0.25	--	mJ
E _{off}	Turn-Off Switching Loss		--	0.27	--	mJ
E _{ts}	Total Switching Loss		--	0.52	--	mJ
Q _g	Total Gate Charge	V _{CE} = 300 V, I _C = 7A, V _{GE} = 15V	--	24	36	nC
Q _{ge}	Gate-Emitter Charge		--	4	6	nC
Q _{gc}	Gate-Collector Charge		--	10	15	nC
L _e	Internal Emitter Inductance	Measured 5mm from PKG	--	7.5	--	nH

Electrical Characteristics of DIODE $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Units
V _{FM}	Diode Forward Voltage	I _F = 7A	T _C = 25°C	--	1.65	2.1	V
			T _C = 100°C	--	1.58	--	
t _{rr}	Diode Reverse Recovery Time	I _F = 7A dI/dt = 200 A/μs	T _C = 25°C	--	50	65	ns
			T _C = 100°C	--	58	--	
I _{rr}	Diode Peak Reverse Recovery Current		T _C = 25°C	--	2.5	3.75	A
			T _C = 100°C	--	3.3	--	
Q _{rr}	Diode Reverse Recovery Charge		T _C = 25°C	--	62.5	122	nC
			T _C = 100°C	--	95.7	--	

Typical Performance Characteristics

Figure 1. Typical Output Characteristics

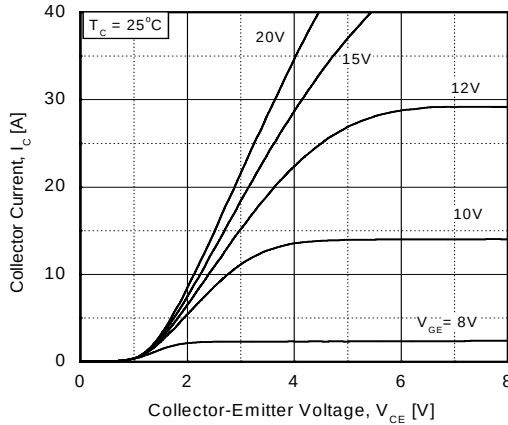


Figure 2. Typical Saturation Voltage Characteristics

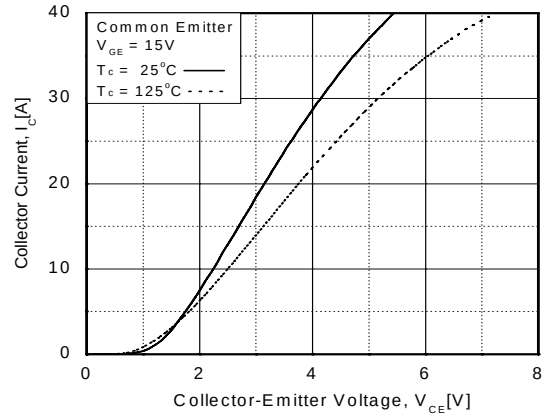


Figure 3. Saturation Voltage vs Case Temperature at Variant Current Level

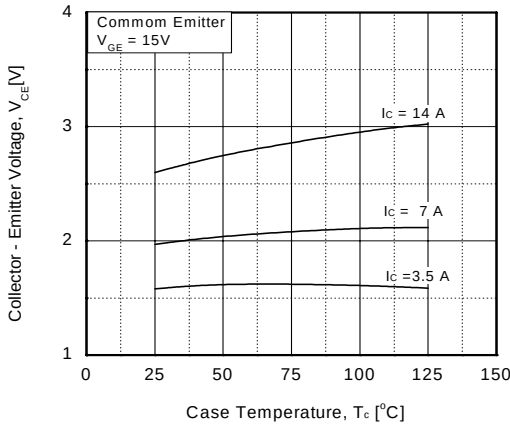


Figure 4. Load Current vs Frequency

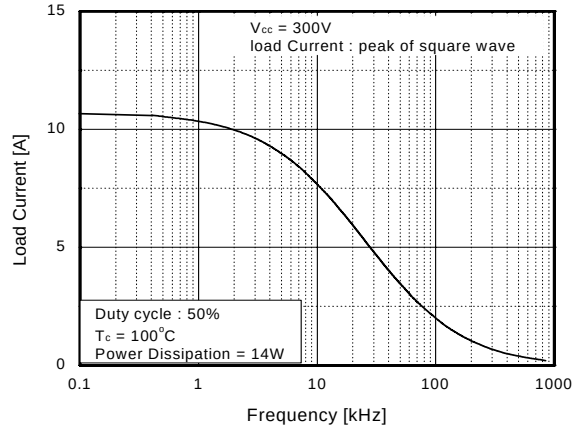


Figure 5. Saturation Voltage vs. Vge

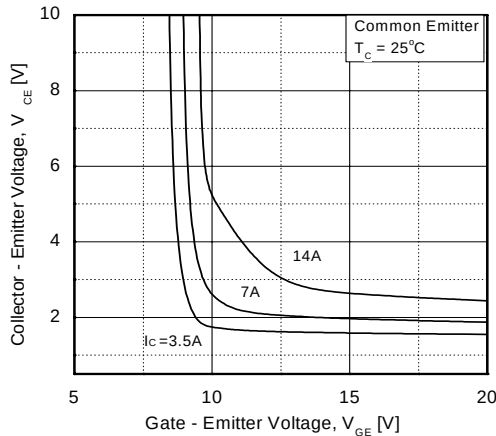
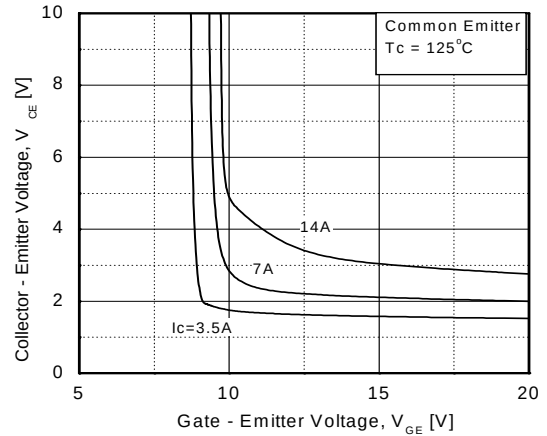


Figure 6. Saturation Voltage vs. Vge



Typical Performance Characteristics (Continued)

Figure 7. Capacitance Characteristics
Temperature at Variant Current Level

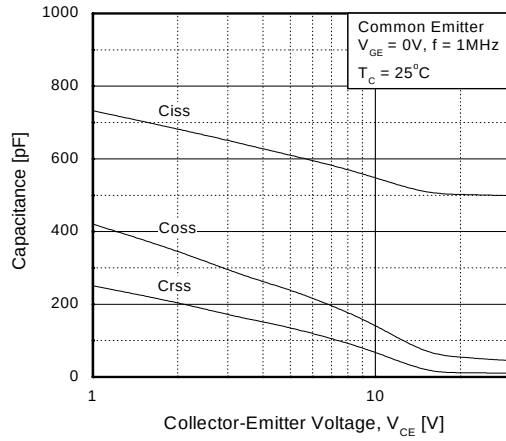


Figure 8. Turn-On Characteristics vs. Gate Resistance

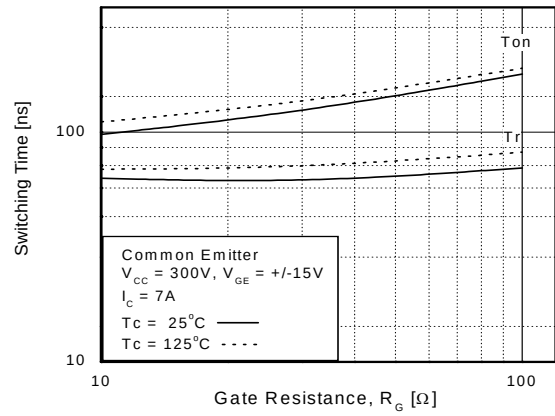


Figure 9. Turn-Off Characteristics vs. Gate Resistance

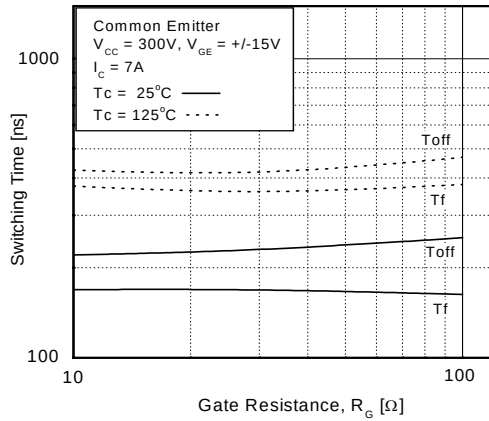


Figure 10. Switching Loss vs. Gate Resistance

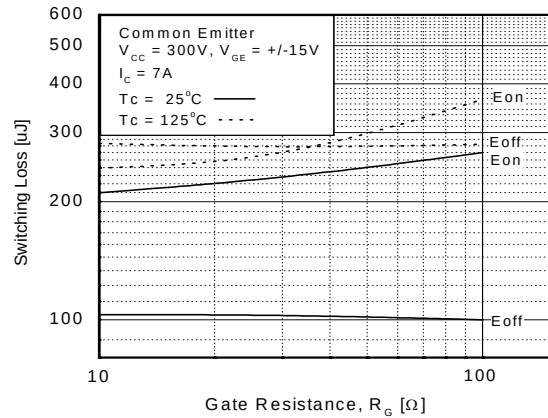


Figure 11. Turn-On Characteristics vs. Collector Current

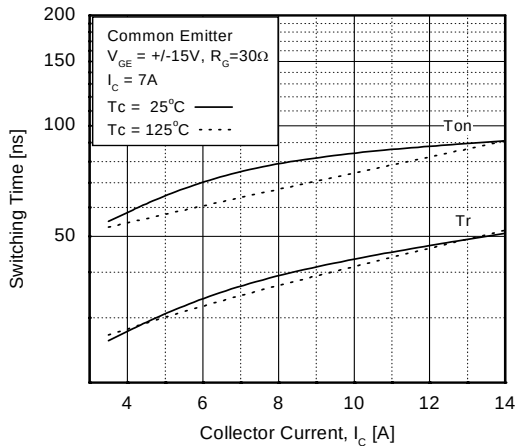
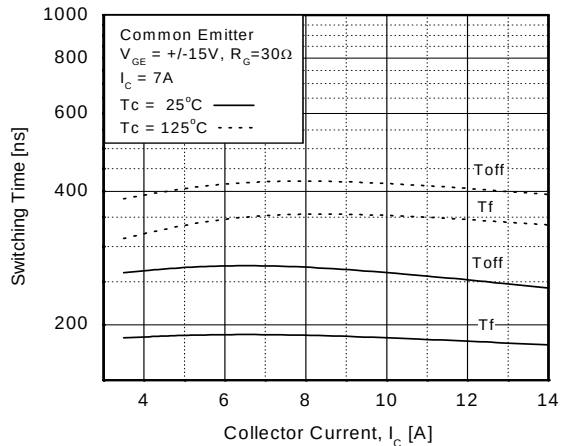


Figure 12. Turn-Off Characteristics vs. Collector Current



Typical Performance Characteristics (Continued)

Figure 13. Switching Loss vs. Collector Current

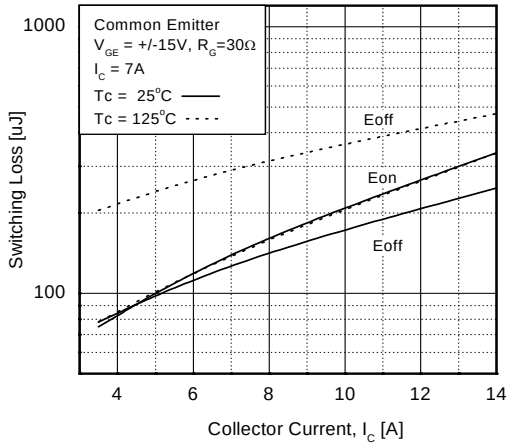


Figure 14. Gate Charge Characteristics

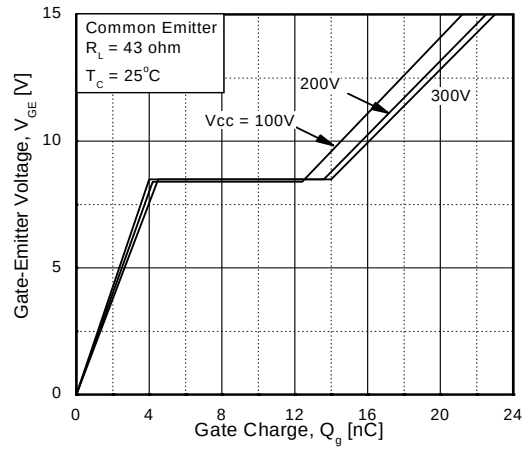


Figure 15. SOA Characteristics

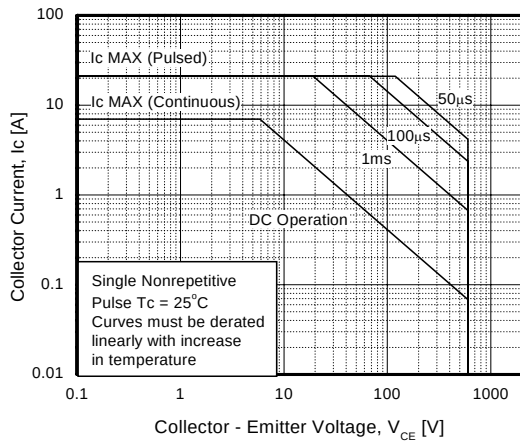
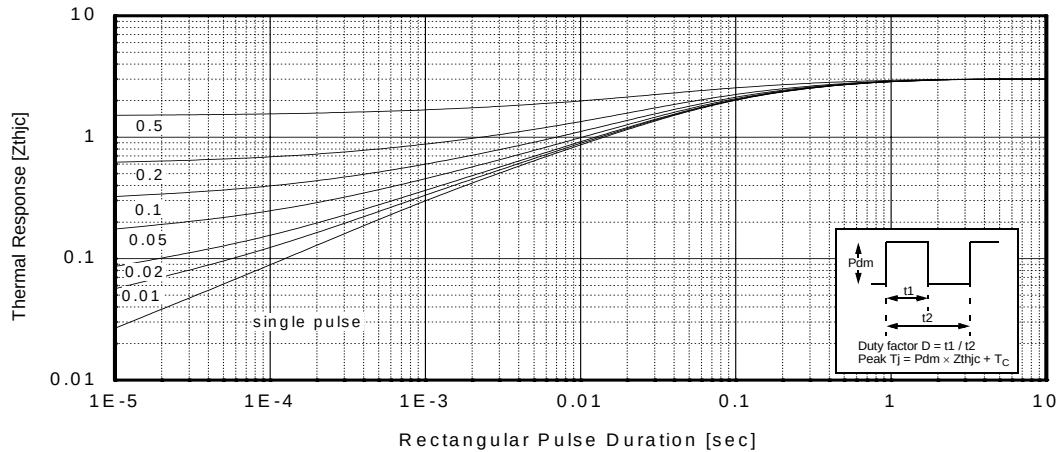


Figure 16. Transient Thermal Impedance of IGBT



Typical Performance Characteristics (Continued)

Figure 17. Forward Voltage Characteristics

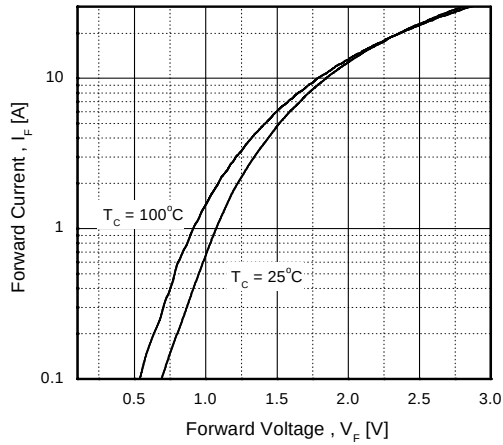


Figure 18. Reverse Recovery Current

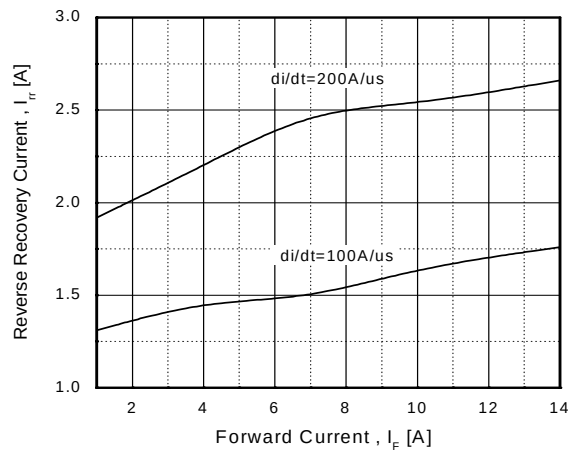


Figure 19. Stored Charge

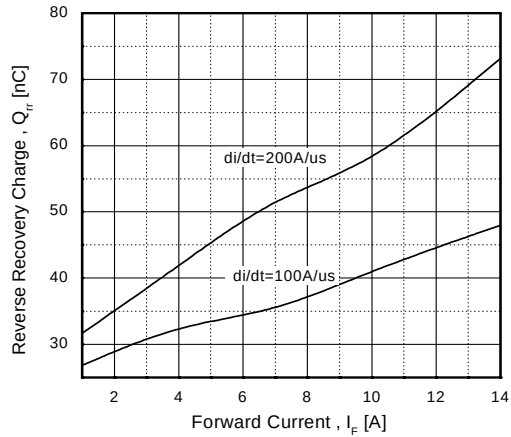
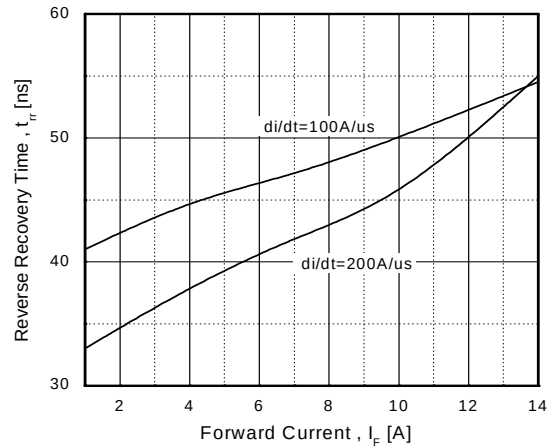


Figure 20. Reverse Recovery Time



Dimensions in Millimeters

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